



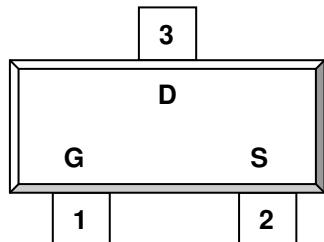
STN1304 
N Channel Enhancement Mode MOSFET

2.0A

DESCRIPTION

STN1304 is the N-Channel logic enhancement mode power field effect transistor which is produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management, other battery powered circuits, and low in-line power loss are required. The product is in a very small outline surface mount package.

PIN CONFIGURATION SOT-323

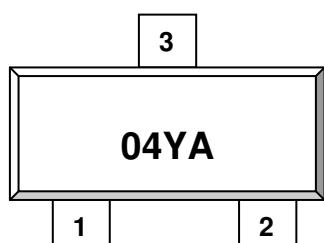


1.Gate 2.Source 3.Drain

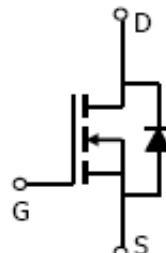
FEATURE

- 20V/2.0A, $R_{DS(ON)} = 225\text{m}\Omega$ @ $VGS = 4.5\text{V}$
- 20V/1.5A, $R_{DS(ON)} = 315\text{m}\Omega$ @ $VGS = 2.5\text{V}$
- 20V/1.0A, $R_{DS(ON)} = 425\text{m}\Omega$ @ $VGS = 4.5\text{V}$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-323 package design

PART MARKING SOT-323



Y: Year Code A: Process Code





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ABSOULTE MAXIMUM RATINGS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	20	V
Gate-Source Voltage	V _{GSS}	±12	V
Continuous Drain Current(T _J =150°C)	I _D	2.0 1.5	A
Pulsed Drain Current	I _{DM}	10	A
Continuous Source Current (Diode Conduction)	I _S	1.6	A
Power Dissipation	P _D	1.25 0.8	W
Operation Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	105	°C/W



STN1304 Pb
Lead-free

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ELECTRICAL CHARACTERISTICS (Ta = 25°C Unless otherwise noted)

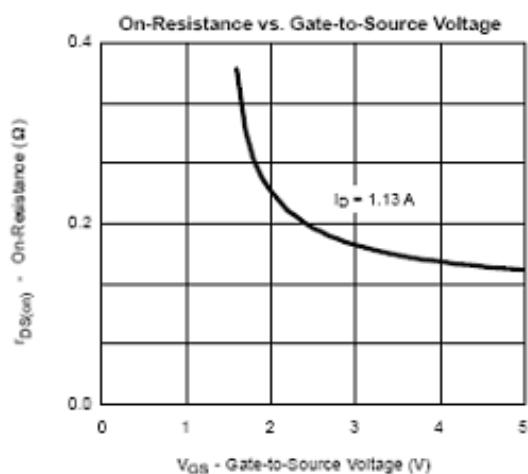
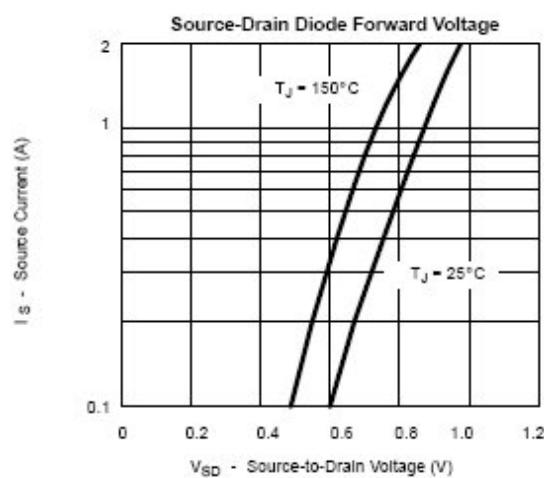
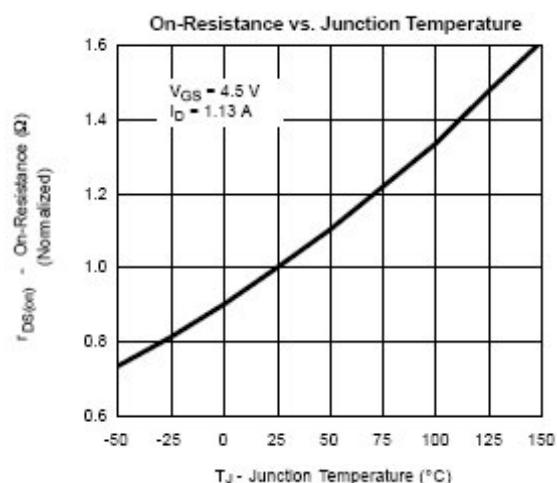
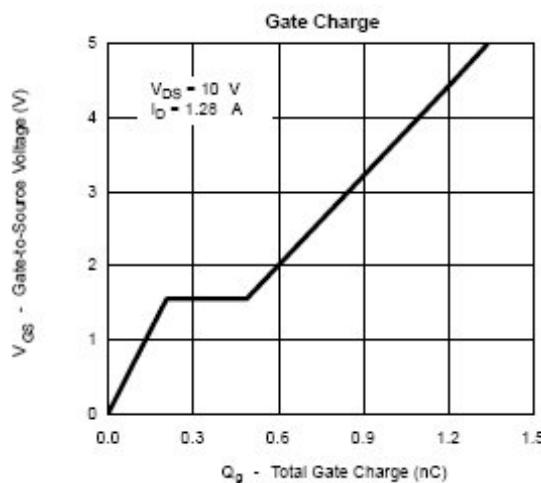
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	20			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.35		1.0	V
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±12V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V, V _{GS} =0V			1	uA
		V _{DS} =20V, V _{GS} =0V T _J =55°C			5	
Drain-source On-Resistance	R _{D(on)}	V _{GS} =4.5V, I _D =2.0A V _{GS} =2.5V, I _D =1.5A V _{GS} =1.8V, I _D =1.0A		0.150 0.210 0.320	0.225 0.315 0.425	Ω
Forward Transconductance	g _f	V _{DS} =10V, I _D =1.2A		10		S
Diode Forward Voltage	V _{SD}	I _S =0.5A, V _{GS} =0V		0.80	1.2	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =10V V _{GS} =4.5V I _D ≡0.7A		1.2	1.5	nC
Gate-Source Charge	Q _{gs}			0.2		
Gate-Drain Charge	Q _{gd}			0.3		
Input Capacitance	C _{iss}	V _{DS} =10V V _{GS} =0V F=1MHz		110		pF
Output Capacitance	C _{oss}			34		
Reverse Transfer Capacitance	C _{rss}			16		
Turn-On Time	t _{d(on)} tr	V _{DD} =10V R _L =10Ω I _D =1.0A V _{GEN} =4.5V R _G =6Ω		5	10	nS
Turn-Off Time	t _{d(off)} tf			8	15	
				10	18	
				1.2	2.8	



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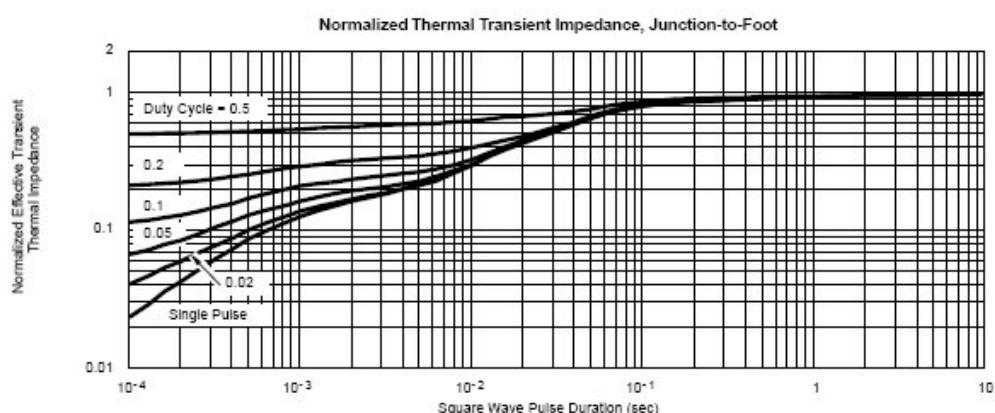
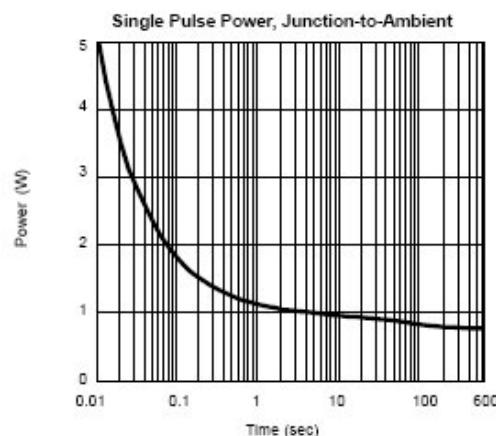
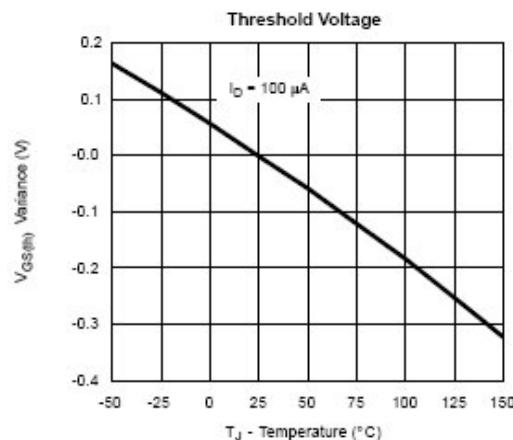


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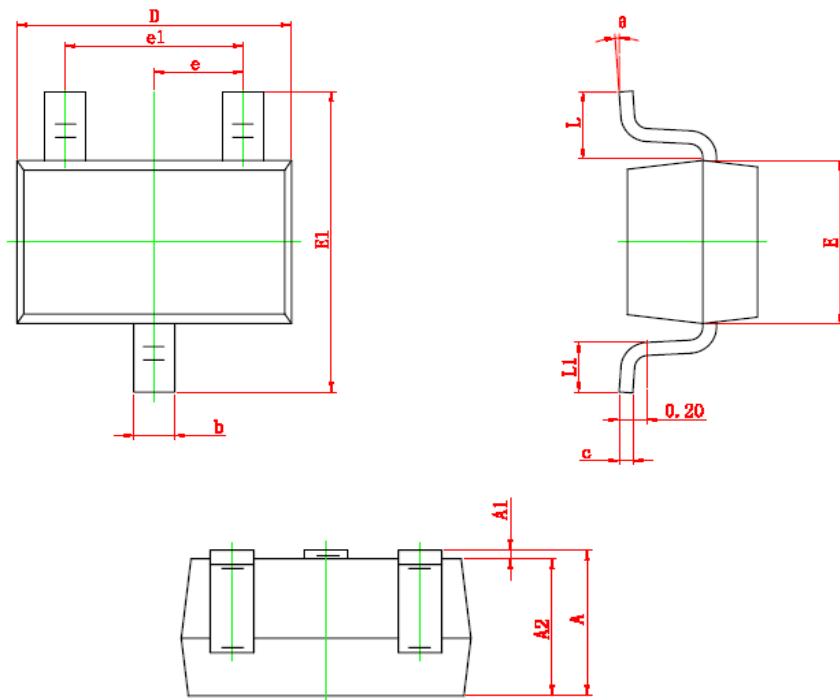




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SOT-323 PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°